Welcome to O-leading

O-Leading strives to be your one stop solution partner in EMS supply chain, including PCB design , PCB fabrication and PCB assembly (PCBA). We provide some of the most advanced PCB technology, including HDI PCBs, multilayer PCBs, Rigid-Flexible PCBs. We can support from quick turn prototype to medium & mass Production.

In general, our global customers are very impressed with our services:rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way O-leading forward. Printed circuit board company

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

We are professional PCB manufacturer with ten years experiences. Products range-single, double side ,multi-layer PCB ,flexible PCB and MCPCB.

We can provide fast prototype service – S/S in 24hrs, 4-8layers in 48-96 working hrs production time. oem mobile phones pcb circuit board with power supply.

Copper plate holes minmum 0.025 avg, 0.020 min. Holes may not be plugged. Pack with colorless transparent bubble film, 25PCS/ bag, put desiccant in flank, put humidity indicator card on top side.

multilayer PCB manufacturer in china

| Place of Origin | Guang dong, China (Mainland) | Brand Name | O-Leading |
|-------------------|---|-------------------|------------------------|
| | | | |
| Base Material | FR-4,,Aluminum | Copper Thickness | 0.5oz-5oz |
| Min. Hole Size | 0.2mm | Min. Line Width | 0.2mm |
| Surface Finishing | immersion gold ,OSP,lead free HASL | Board Thickness | 0.1-5mm |
| applicable to | led,mobile phone,air conditioners,washing machines | character | Industrial Control pcb |
| certificates | ISO9001,UL,RoHS,SGS | Q/CTN | 10PCS-100PCS |
| weight | 0.01kg -5kg | MOQ | 10pcs |
| color | blue ,red ,green,black.yellow | Min. Line Spacing | 0.2mm |
| Model Number | power bank pcb assembly pcba manufacturer | price | \$0.1-\$10 |
| desigh type | client requirement | size | 0.01m3-10m3 |

Double sided pcb supplier

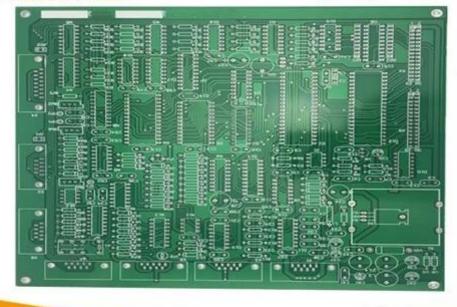












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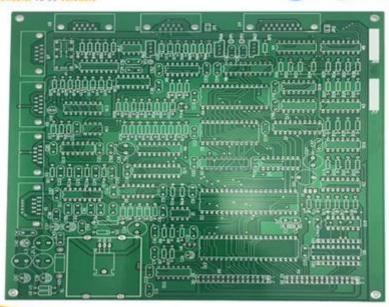












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Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT













Certifications







Test Report

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

No. SZXEC1900530401

1313,FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

Date: 30 Mar 2019 Page 1 of 6

Test Report No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

Test Part Description :

 Specimen No.
 SGS Sample ID
 Description

 SN1
 SZX19-005304.001
 Green*PCB**

(1) 1 mg/kg = 1 ppm = 0.0001% (2) MDL = Method Detection Limit

(3) ND = Not Detected (< MDL)

(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC682321-5:2013, IEC62321-7:2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

| Test Item(s) | Limit | Unit | MDL | 001 |
|------------------------------|-------|-------|-----|-----|
| Cadmium (Cd) | 100 | mg/kg | 2 | ND |
| Lead (Pb) | 1,000 | mg/kg | 2 | 8 |
| Mercury (Hg) | 1,000 | mg/kg | 2 | ND |
| Hexavalent Chromium (Cr(VI)) | 1,000 | mg/kg | 8 | ND |
| Sum of PBBs | 1.000 | mg/kg | | ND |
| Monobromobiphenyl | | mg/kg | 5 | ND |
| Dibromobiphenyl | 12 | mg/kg | 5 | ND |
| Tribromobiphenyl | 15 | mg/kg | 5 | ND |
| Tetrabromobiphenyl | | mg/kg | 5 | ND |
| Pentabromobiphenyl | | mg/kg | 5 | ND |
| Hexabromobiphenyl | | mg/kg | 5 | ND |
| Heptabromobiphenyl | | mg/kg | 5 | ND |
| Octabromobiphenyl | | mg/kg | 5 | ND |
| Nonabromobiphenyl | 6 | mg/kg | 5 | ND |
| Decabromobiphenyl | | mg/kg | 5 | ND |
| Sum of PBDEs | 1,000 | mg/kg | | ND |
| Monobromodiphenyl ether | | mg/kg | 5 | ND |
| Dibromodiphenyl ether | 12 | mg/kg | 5 | ND |
| Tribromodiphenyl ether | 2 | mg/kg | 5 | ND |
| Tetrabromodiphenyl ether | - | mg/kg | 5 | ND |
| Pentabromodiphenyl ether | | mg/kg | 5 | ND |



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- Remark (14.0 post-times-days-scene)
(2586g to 4.1 post-times-form) (14.0 post-times-for

Member of the SGS Group (SGS SA)

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ Date of Sample Received : 22 Mar 2019

22 Mar 2019 - 30 Mar 2019 Testing Period :

Test Requested : Selected test(s) as requested by client. Test Method Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion:

Based on the performed tests on submitted sample(s), the results of Lead. Mercury, Cadmium, Hexavalent chiromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBBcs) and Phthalates such as Bis(2-ethylbexyl) phthalate (DBFP). Bibutyl phthalate (DBFP). To butyl phthalate (DBFP), and Diisobutyl phthalate (DBFP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU.

Signed for and on behalf of SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

lina

Tina Fan Approved Signatory



Max

Max

UL Product iQ™



ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

Cond Width

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F TAI SANG BANK BLDG 130-132 DES VOEUS ROAD CENTRAL, HONG KONG

| | | Min | Cond | SS/ | Area | Solo | der | Oper | | Meets | c |
|-------------------|---|---------------|----------------------|-----|------------|------|-----|------|-------|--------------|-----|
| | Min | Edge | Thk | DS/ | Diam | Lim | its | Temp | Flame | UL796 | T |
| Туре | mm(in) | mm(in) | mic(mil) | DSO | mm(in) | c | sec | c | Class | DSR | 1 |
| Multilayer (m | Multilayer (mass laminate) printed wiring boards. | | | | | | | | | | |
| O-LEADING- 401 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 12.7 (0.5) | 260 | 10 | 130 | V-0 | 3 | 153 |
| O-LEADING- 407 | 0.08 (0.003) | 0.2 (0.008) | 17 (0.67) | DS | 9.7 (0.4) | 260 | 10 | 130 | V-0 | All | - |
| Multilayer pri | nted wiring bo | ards. | | | | | | | 3 | | |
| O-LEADING- 408 | 0.125 (0.005) | 0.125 (0.005) | 12 (0.47) Int:136 | DS | 50.8 (2.0) | 280 | 20 | 130 | V-0 | All | * |
| Single layer p | rinted wiring b | oards. | | | | | | | 3 77 | 7.57 | |
| O-LEADING- 002 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 105 | V-0 | All | - |
| O-LEADING- 003 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 130 | V-0 | A | - |
| O-LEADING- 033 | 0.15 (0.006) | 0.3 (0.012) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 10 | 120 | V-0 | All | - |
| O-LEADING- 205 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | - |
| O-LEADING- 206 | 0.15 (0.006) | 0.33 (0.013) | 17 (0.67) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | |
| O-LEADING- D01 | 0.14 (0.006) | 0.15 (0.006) | 33 (1.30) | DS | 25.4 (1.0) | 260 | 10 | 130 | V-0 | All | * |
| O-LEADING- S01 | 0.25 (0.010) | 0.25 (0.010) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

WIRING, PRINTED - COMPONENT | UL Product iQ

| O-LEADING- S02 | 0.2 (0.008) | 0.2 (0.008) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | НВ | A | * |
|-------------------|--------------|--------------|-----------|----|------------|-----|---|-----|-----|----------|---|
| O-LEADING- S03 | 0.25 (0.010) | 0.25 (0.010) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

 $[\]mbox{\ensuremath{\star}}$ - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Packaging & Delivery

Shipping service











| | Quick Turn Lead Time | | | | | |
|--------------|----------------------|---------------------|--|--|--|--|
| Layer Count: | Lead Tim | Special Requirement | | | | |
| 1L/2L | 2-3days | 24 Hours,48 Hours | | | | |
| 4L | 3-4days | 48 Hours | | | | |
| 6L | 4-5days | 72 Hours | | | | |
| 8L | 5-6days | NA | | | | |
| 10L | 6-7days | NA | | | | |
| 12L | 7-8days | NA | | | | |
| 14L | 8-9days | NA | | | | |

| | Standard Lead Time | | | | | |
|--------------|--------------------|------------------------|--|--|--|--|
| Layer Count: | Sample Lead Time | Volume order lead time | | | | |
| 2L | 4 days | 10 days | | | | |
| 4L | 5 days | 11 days | | | | |
| 6L | 6 days | 12 days | | | | |
| 8L | 8 days | 14 days | | | | |
| 10L | 10 days | 16 days | | | | |
| 12L | 12 days | 18 days | | | | |
| 14L | 14 days | 20 days | | | | |
| 16-32L | 18 days | 24 days | | | | |

Process Capability

PCB Production Capabilities

Layer Count: 1Layer-32Layer

Finished copper thickness 1/3oz-12oz

Min Line width/spacing internal ☐ 3.0mil/3.0mil Min Line width/spacing external: 4.0mil/4.0mil

Max Aspect Ratio: 10:1

Board thickness[] 0.2mm-5.0mm
Max Panel size(inches): 635*1500mm
Minimum Drilled Hole Size: 4mil
Plated Hole Tolerance: +/-3mil
Blind/Buried Vias (All Types): YES
Via Fill(Conductive,Non-Conductive): YES

Base Material: FR-4,FR-4high Tg.Halogen free material,Rogers,Aluminium base,Polyimide,

Heavy Copper

Surface finishes: HASL,OSP,ENIG,HAL-LF,Immersion silver,Immersion Tin,Gold fingers,Carbon ink

SMT Production Capabilities

PCB Material: FR-4,CEM-1,CEM-3,Aluminum-based board

Max PCB size: 510x460mm Min PCB size 50x50mm PCB Thickness 0.5mm-4.5m

PCB Thickness□0.5mm-4.5mm Board thickness□0.5-4mm Min Components size: 0201

Standard chip size component: 0603 and larger

Component max height
☐15mm

Min lead pitch: 0.3mm Min BGA ball pitch:0.4mm

Placement precision: +/-0.03mm